

CX4HGSM AT CRYSTAL

14 MHz to 50 MHz **High Shock**, Ultra-Miniature, Low Profile Surface Mount AT Quartz Crystal

DESCRIPTION

Intended for applications requiring shock survivability up to 100,000 g, Statek's surface-mount CX4HGSM crystals are high-shock versions of the CX4SM crystals.

FEATURES

- High shock and vibration resistance
- Designed for surface mount applications using infrared, vapor phase, or epoxy mount techniques.
- Low profile (less than 1.2 mm) hermetically sealed ceramic package
- Available with glass or ceramic lid
- Custom designs available
- Full military testing available
- Designed and manufactured in the USA

APPLICATIONS

Industrial & Communications

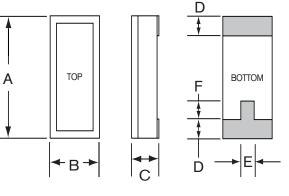
- Down-hole Data Recorder
- Process Control
- Environmental Control
- Engine Control
- Telemetry
- Ruggedized Instrumentation
- Automotive Control

Military & Aerospace

- Smart Munitions
- Timing Devices (Fuzes)
- Surveillance Devices
- Missile Telemetry
- Ruggedized Communications
- Aviation Equipment



PACKAGE DIMENSIONS



	TYPICAL		MAXI	MUM	
DIM	inches	mm	inches	mm	
А	0.197	5.00	0.210	5.33	
В	0.072	1.83	0.085	2.16	
С	_	—	see b	elow	
D	0.036	0.91	0.046	1.16	
Е	0.020	0.51			
F	0.025	0.64			

THICKNESS (DIM C) MAXIMUM

	GLASS LID		CERAN	IIC LID
	inches	mm	inches	mm
SM1	0.045	1.14	0.050	1.27
SM2/SM4	0.046	1.17	0.051	1.30
SM3/SM5	0.048	1.22	0.053	1.35

10165 Rev B

SGS



SPECIFICATIONS

Specifications are	typical at 25°C unless	s otherwise noted	Specifications :	are subject to change	without notice
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Fundamental Frequency	<u>14.7456 MHz</u>	<u>16MHz</u>	<u>20 MHz</u>	<u>32 MHz</u>	<u>40 MHz</u>	
Motional Resistance R_1 (Ω)	60	75	50	30	30	
Motional Capacitance C_1 (fF)	1.4	1.5	1.4	2.5	1.5	
Quality Factor Q (k)	120	90	110	70	90	
Shunt Capacitance C_0 (pF)	0.8	0.9	0.9	1.1	1.0	
Frequency Range ¹	14 MHz to 50 MHz		TERM		15	
Calibration Tolerance ² Load Capacitance	± 100 ppm, or tighter a 10 pF (unless specified oth	•	<u>Designa</u> SM1		<u>nation</u> Plated (Lead Fre	ee
Drive Level	200 µW MAX		SM2	Solder	Plated	
Frequency-Temperature Stability ^{2,3}	[±] 50 ppm to [±] 10 pp [±] 100 ppm to [±] 20 pp [±] 100 ppm to [±] 30 pp	m (Industrial)	al) SM3 SM4 SM5	Solder	Dipped Plated (Lead F Dipped (Lead	
Aging, first year⁴	10 ppm MAX		Max Pro	cess Tempe	erature 260°0	С
Shock, survival	Up to 100,000 g, 0.5	ms, $^{1}/_{2}$ sine	EQUI	VALENT	CIRCUIT	
Vibration, survival⁵	20 g, 10-2,000 Hz sw	ept sine			C	
Operating Temp. Range	-10°C to +70°C (Con -40°C to +85°C (Indu -55°C to +125°C (Milit	ustrial)	1	L ₁	−−−1 -−− C ₁	
Storage Temp. Range	-55°C to +125°C		l		└──┤┝──	_/

Max Process Temperature 260°C for 20 sec

1. Other frequencies available. Contact factory.

2. Other tolerances available. Contact factory.

3. Does not include calibration tolerance. The characteristics of the frequency stability over temperature follow that of the AT thickness-shear mode.

4. Lower aging available at low shock levels.

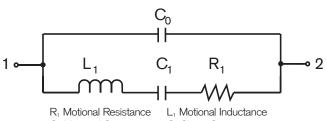
5. Per MIL-STD-202G, Method 204D, Condition D. Random vibration testing also available.

PACKAGING OPTIONS

- Tray Pack
- Tape and Reel Per EIA 481 (see Tape and Reel data sheet 10109)

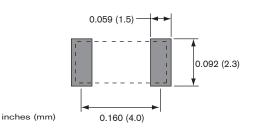
<u>Designation</u>	Termination
SM1	Gold Plated (Lead Free)
SM2	Solder Plated
SM3	Solder Dipped
SM4	Solder Plated (Lead Free)
SM5	Solder Dipped (Lead Free)

C for 20 sec

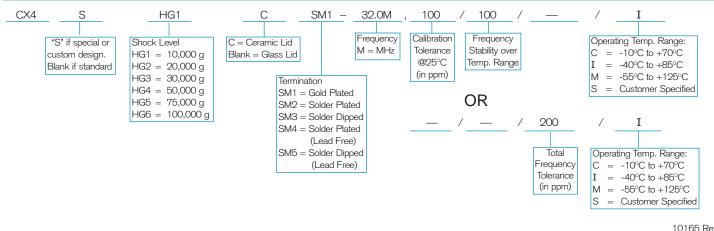


C1 Motional Capacitance Co Shunt Capacitance

SUGGESTED LAND PATTERN



HOW TO ORDER CX4HGSM AT CRYSTALS



10165 Rev B

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